

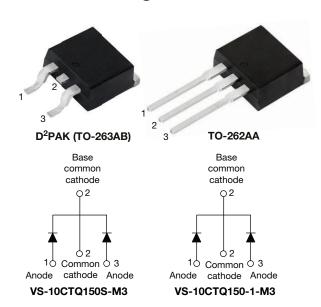
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Vishay Semiconductors

COMPLIANT HALOGEN

**FREE** 

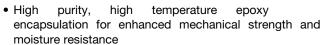
# High Performance Schottky Rectifier, 2 x 5 A



PRIMARY CHARACTERISTICS				
I <sub>F(AV)</sub>	2 x 5 A			
$V_{R}$	150 V			
V <sub>F</sub> at I <sub>F</sub>	0.93 V			
I <sub>RM</sub>	7 mA at 125 °C			
T <sub>J</sub> max.	175 °C			
E <sub>AS</sub>	5 mJ			
Package	D <sup>2</sup> PAK (TO-263AB), TO-262AA			
Circuit configuration	Common cathode			

#### **FEATURES**

- 175 °C T<sub>J</sub> operation
- Center tap configuration
- Low forward voltage drop
- · High frequency operation



- Guard ring for enhanced ruggedness and long term reliability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 245 °C
- Designed and qualified according to JEDEC®-JESD 47
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

#### **DESCRIPTION**

This center tap Schottky rectifier has been optimized for low reverse leakage at high temperature. The proprietary barrier technology allows for reliable operation up to 175 °C junction temperature. Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS						
SYMBOL	SYMBOL CHARACTERISTICS VALUES UN					
I <sub>F(AV)</sub>	Rectangular waveform	10	A			
V <sub>RRM</sub>		150	V			
I <sub>FSM</sub>	t <sub>p</sub> = 5 μs sine	620	Α			
V <sub>F</sub>	5 A <sub>pk</sub> , T <sub>J</sub> = 125 °C (per leg)	0.73	V			
T <sub>J</sub>	Range	-55 to +175	°C			

VOLTAGE RATINGS					
PARAMETER	SYMBOL	VS-10CTQ150S-M3 VS-10CTQ150-1-M3	UNITS		
Maximum DC reverse voltage	$V_{R}$	150	V		
Maximum working peak reverse voltage	$V_{RWM}$	150	V		



# VS-10CTQ150S-M3, VS-10CTQ150-1-M3

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ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	TEST COND	VALUES	UNITS		
Maximum average per leg		50 % duty cycle at T <sub>C</sub> = 155 °C, rectangular waveform		5	А	
forward current, see fig. 5 per device	I <sub>F(AV)</sub>			10		
Maximum peak one cycle non-repetitive		5 μs sine or 3 μs rect. pulse Following any rated load		620		
surge current per leg, see fig. 7	I <sub>FSM</sub>	10 ms sine or 6 ms rect. pulse	condition and with rated V <sub>RRM</sub> applied	115	Α	
Non-repetitive avalanche energy per leg	E <sub>AS</sub>	$T_J = 25$ °C, $I_{AS} = 1$ A, L = 10 mH		5	mJ	
Repetitive avalanche current per leg	I <sub>AR</sub>	Current decaying linearly to zero in 1 $\mu$ s Frequency limited by T <sub>J</sub> maximum V <sub>A</sub> = 1.5 x V <sub>B</sub> typical		1	Α	

ELECTRICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CO	NDITIONS	VALUES	UNITS	
		5 A	T <sub>.1</sub> = 25 °C	0.93		
Maximum forward voltage drop per leg	V <sub>FM</sub> <sup>(1)</sup>	10 A	11 = 23 0	1.10	V	
See fig. 1	VFM (1)	5 A	T <sub>.1</sub> = 125 °C	0.73		
		10 A	1 J = 125 C	0.86		
Maximum reverse leakage current per	ı (1)	T <sub>J</sub> = 25 °C	V <sub>B</sub> = Rated V <sub>B</sub>	0.05	mA	
leg See fig. 2	I <sub>RM</sub> <sup>(1)</sup>	T <sub>J</sub> = 125 °C	v <sub>R</sub> = nateu v <sub>R</sub>	7		
Threshold voltage	V <sub>F(TO)</sub>	T T marriage		0.468	V	
Forward slope resistance	r <sub>t</sub>	$T_J = T_J$ maximum		28	mΩ	
Maximum junction capacitance per leg	C <sub>T</sub>	V <sub>R</sub> = 5 V <sub>DC</sub> (test signal range	200	pF		
Typical series inductance per leg	L <sub>S</sub>	Measured lead to lead 5 mm from package body 8.0			nH	
Maximum voltage rate of change	dV/dt	Rated V <sub>R</sub> 10 000			V/µs	

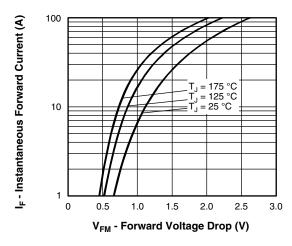
#### Note

 $<sup>^{(1)}\,</sup>$  Pulse width < 300 µs, duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS					
PARAMETER		SYMBOL	SYMBOL TEST CONDITIONS		UNITS
Maximum junction and statemperature range	orage	T <sub>J</sub> , T <sub>Stg</sub>		-55 to +175	°C
Maximum thermal resistance, junction to case per leg		- R <sub>th.JC</sub>	DC operation	3.50	
Maximum thermal resistance, junction to case per package		□thJC	DO operation	1.75	°C/W
Typical thermal resistance, case to heatsink (only for TO-220)		R <sub>thCS</sub>	Mounting surface, smooth and greased	0.50	
Approximate weight				2	g
Approximate weight				0.07	OZ.
Mounting torque minimum				6 (5)	kgf · cm
Mounting torque maximum				12 (10)	(lbf · in)
Madina dada			Case style D <sup>2</sup> PAK (TO-263AB)	10CTQ1	50S
Marking device			Case style TO-262AA	10CTQ1	50-1

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100  $T_{J} = 175 \, ^{\circ}\text{C}$ 10 I<sub>R</sub> - Reverse Current (mA) T<sub>J</sub> = 150 °C T<sub>J</sub> = 125 °C 0.1 0.01 = 75 °C T<sub>J</sub> = 50 °C 0.001 = 25 °C 0.0001 25 50 75 100 125 150 V<sub>R</sub> - Reverse Voltage (V)

Fig. 1 - Maximum Forward Voltage Drop Characteristics (Per Leg)

Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage (Per Leg)

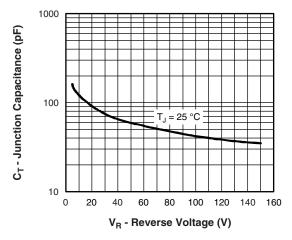


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

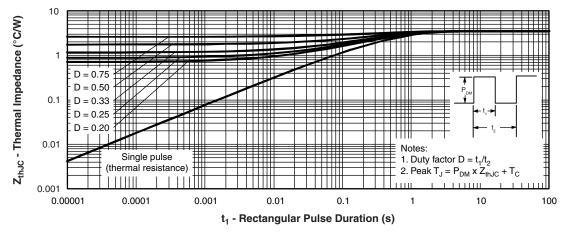


Fig. 4 - Maximum Thermal Impedance ZthJC Characteristics (Per Leg)



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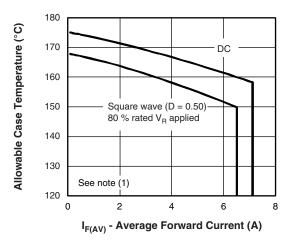


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current (Per Leg)

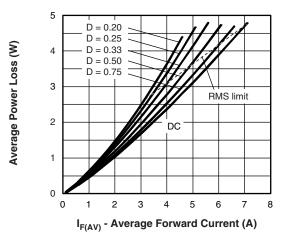


Fig. 6 - Forward Power Loss Characteristics (Per Leg)

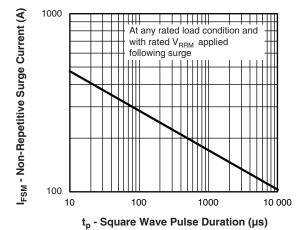


Fig. 7 - Maximum Non-Repetitive Surge Current (Per Leg)

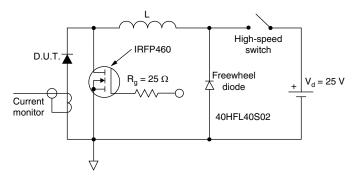


Fig. 8 - Unclamped Inductive Test Circuit

#### Note

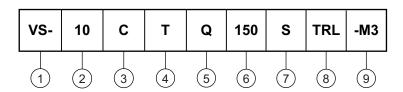
 $\begin{array}{ll} \text{(1)} & \text{Formula used: } T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}; \\ Pd = \text{forward power loss} = I_{F(AV)} \times V_{FM} \text{ at } (I_{F(AV)}/D) \text{ (see fig. 6)}; \\ Pd_{REV} = \text{inverse power loss} = V_{R1} \times I_R \text{ (1 - D)}; I_R \text{ at } V_{R1} = 10 \text{ V}. \end{array}$ 

# VS-10CTQ150S-M3, VS-10CTQ150-1-M3

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#### **ORDERING INFORMATION TABLE**

**Device code** 



1 - Vishay Semiconductors product

2 - Current rating (10 A)

3 - Circuit configuration: C = common cathode

**4** - T = TO-220

5 - Schottky "Q" series

Voltage rating (150 = 150 V)

7 - • S =  $D^2$ PAK (TO-263AB)

• -1 = TO-262AA

• None = tube (50 pieces)

• TRL = tape and reel (left oriented - for D<sup>2</sup>PAK (TO-263AB) only)

• TRR = tape and reel (right oriented - for D<sup>2</sup>PAK (TO-263AB) only)

9 - -M3 = halogen-free, RoHS-compliant, and termination lead (Pb)-free

ORDERING INFORMATION (Example)						
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION			
VS-10CTQ150S-M3	50	1000	Antistatic plastic tubes			
VS-10CTQ150STRR-M3	800	800	13" diameter reel			
VS-10CTQ150STRL-M3	800	800	13" diameter reel			
VS-10CTQ150-1-M3	50	1000	Antistatic plastic tubes			

LINKS TO RELATED DOCUMENTS			
Dimensions	D <sup>2</sup> PAK (TO-263AB)	www.vishay.com/doc?96164	
Dimensions	TO-262AA	www.vishay.com/doc?96165	
Part marking information	D <sup>2</sup> PAK (TO-263AB)	www.vishay.com/doc?95444	
Fart marking information	TO-262AA	www.vishay.com/doc?95443	
Packaging information		www.vishay.com/doc?96424	



# Vishay Semiconductors

# D<sup>2</sup>PAK

#### **DIMENSIONS** in millimeters and inches



SYMBOL	MILLIMETERS		INC	INCHES		SYMBOL	MILLIM	ETERS	INC	HES	NOTES
STIVIBUL	MIN.	MAX.	MIN.	MAX.	NOTES	STWIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.06	4.83	0.160	0.190		D1	6.86	8.00	0.270	0.315	3
A1	0.00	0.254	0.000	0.010		Е	9.65	10.67	0.380	0.420	2, 3
b	0.51	0.99	0.020	0.039		E1	7.90	8.80	0.311	0.346	3
b1	0.51	0.89	0.020	0.035	4	е	2.54	BSC	0.100	) BSC	
b2	1.14	1.78	0.045	0.070		Н	14.61	15.88	0.575	0.625	
b3	1.14	1.73	0.045	0.068	4	L	1.78	2.79	0.070	0.110	
С	0.38	0.74	0.015	0.029		L1	-	1.65	-	0.066	3
c1	0.38	0.58	0.015	0.023	4	L2	1.27	1.78	0.050	0.070	
c2	1.14	1.65	0.045	0.065		L3	0.25	BSC	0.010	BSC	
D	8.51	9.65	0.335	0.380	2	L4	4.78	5.28	0.188	0.208	

#### Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inch
- (7) Outline conforms to JEDEC® outline TO-263AB

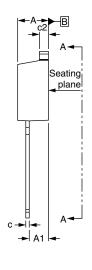


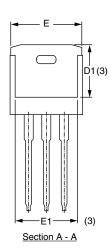
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#### **TO-262**

#### **DIMENSIONS** in millimeters and inches

# Modified JEDEC outline TO-262 (Datum A) (2) (3) (3) L1 D D D C C C C A (2) A (2) A (3) L2 B B B B C C C A (2)



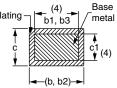


**⊕** 0.010**⋒**|A**⋒**|B

#### Lead assignments



<u>Diodes</u>
1. - Anode (two die)/open (one die)
2., 4. - Cathode
3. - Anode



Section B - B and C - C Scale: None

CVMPOL	MILLIN	METERS	INCH	IES	NOTES
SYMBOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.06	4.83	0.160	0.190	
A1	2.03	3.02	0.080	0.119	
b	0.51	0.99	0.020	0.039	
b1	0.51	0.89	0.020	0.035	4
b2	1.14	1.78	0.045	0.070	
b3	1.14	1.73	0.045	0.068	4
С	0.38	0.74	0.015	0.029	
c1	0.38	0.58	0.015	0.023	4
c2	1.14	1.65	0.045	0.065	
D	8.51	9.65	0.335	0.380	2
D1	6.86	8.00	0.270	0.315	3
E	9.65	10.67	0.380	0.420	2, 3
E1	7.90	8.80	0.311	0.346	3
е	2.54	BSC	0.100	BSC	
L	13.46	14.10	0.530	0.555	
L1	-	1.65	-	0.065	3
L2	3.56	3.71	0.140	0.146	

#### Notes

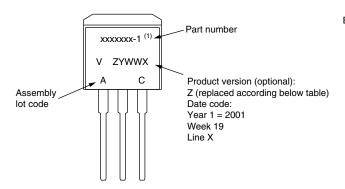
- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- $^{(3)}$  Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Controlling dimension: inches
- (6) Outline conform to JEDEC TO-262 except A1 (maximum), b (minimum) and D1 (minimum) where dimensions derived the actual package outline



# **Part Marking Information**

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#### **TO-262**



Example: This is a xxxxxxx-1 <sup>(1)</sup> with assembly lot code AC, assembled on WW 19, 2001

in the assembly line "X"

#### Note

(1) If part number contain "H" as last digit, product is AEC-Q101 qualified

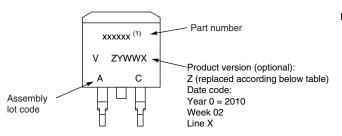
ENVIRONMENTAL NAMING CODE (Z)	PRODUCT DEFINITION		
A	Termination lead (Pb)-free		
В	Totally lead (Pb)-free		
E	RoHS-compliant and termination lead (Pb)-free		
F	RoHS-compliant and totally lead (Pb)-free		
М	Halogen-free, RoHS-compliant and termination lead (Pb)-free		
N	Halogen-free, RoHS-compliant and totally lead (Pb)-free		
G Green			



# **Part Marking Information**

Vishay Semiconductors

#### D<sup>2</sup>PAK



Example: This is a xxxxxx <sup>(1)</sup> with assembly lot code AC, assembled on WW 02, 2010

#### Note

(1) If part number contain "H" as last digit, product is AEC-Q101 qualified

ENVIRONMENTAL NAMING CODE (Z) PRODUCT DEFINITION				
А	Termination lead (Pb)-free			
В	Totally lead (Pb)-free			
E	RoHS-compliant and termination lead (Pb)-free			
F	RoHS-compliant and totally lead (Pb)-free			
M	Halogen-free, RoHS-compliant, and termination lead (Pb)-free			
N	Halogen-free, RoHS-compliant, and totally lead (Pb)-free			
G	Green			



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